

**TEST PHOTOGRAPHS CONCERNING THE
COMPLIANCE OF AN INTEL® WIRELESS GIGABIT
SINK W13100 LINK, BRAND INTEL, MODEL
13100NGW (INCLUDING 13100NGW LC) WITH THE
STANDARD:
47 CFR PART 15: 2013 AND ICES-003: 2012 (CLASS
B CERTIFICATION). FOR DETAILS SEE REPORT
14050902.F02.VER02**

FCC listed : 90828
Industry Canada : 2932G-2
R&TTE, LVD, EMC Notified Body : 1856

TÜV Rheinland Nederland B.V.
P.O. Box 37
9350 AA Leek (NL)
Eiberkamp 10
9351 VT Leek (NL)

Telephone: +31 594 505005
Telefax: +31 594 504804

Internet: www.tuv.com
E-mail: eps@nl.tuv.com

Description of test item

Project number : 14050902.f02.VER02
Test item : Intel ® Wireless Gigabit Sink W13100 Link
Manufacturer : Intel Mobile Communications S.A.
Brand : Intel
Model : 13100NGW Including 13100NGWLC
Serial number. : n.a.
Receipt date : September 17, 2014

Applicant information

Applicant's representative : Mr. S.C. Hackett
Company : Intel Mobile Communications
Address : 100 Center Point Circle, Suite 200
Postal code : Columbia, South Carolina
City : 29310
PO-box : ---
Postal code : ---
City : ---
Country : United States of America
Telephone number : + 1 803-216-2344
Telefax number : + 1 803-216-2676
Email Address : Steven.c.hackett@intel.com

Table of contents

1	Photographs of the equipment.	4
1.1	Laptop with EUT Inside	4
1.2	EUT backside	4
1.3	EUT frontside	5
1.4	Set-up RF Radiated Emission up to 1 GHz.....	6
1.5	Set-up RF Radiated Emission > 1 GHz	7
1.6	Set-up for Conducted Emission (Laptop Power Supply).....	8

1 Photographs of the equipment.

1.1 Laptop with EUT Inside



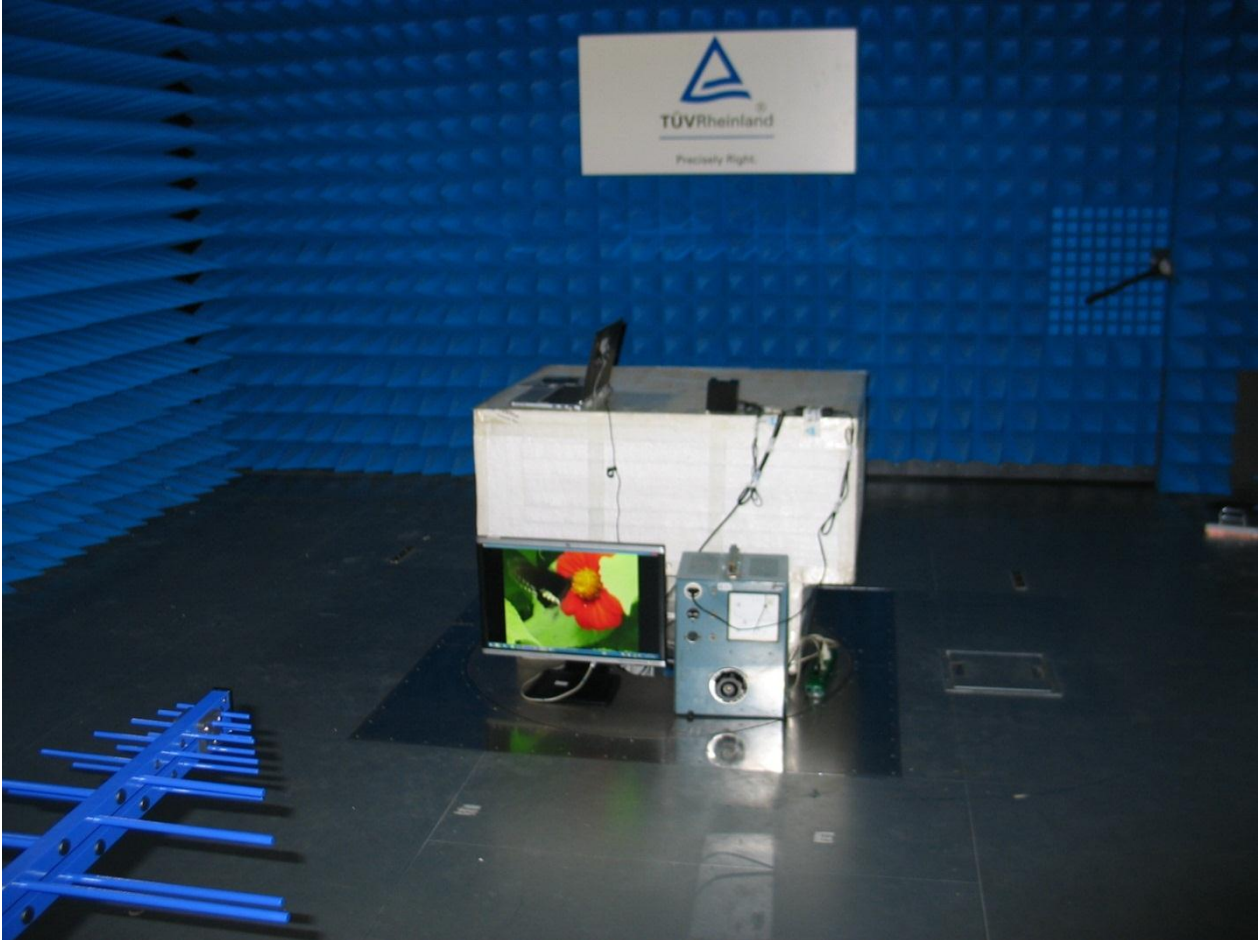
1.2 EUT backside



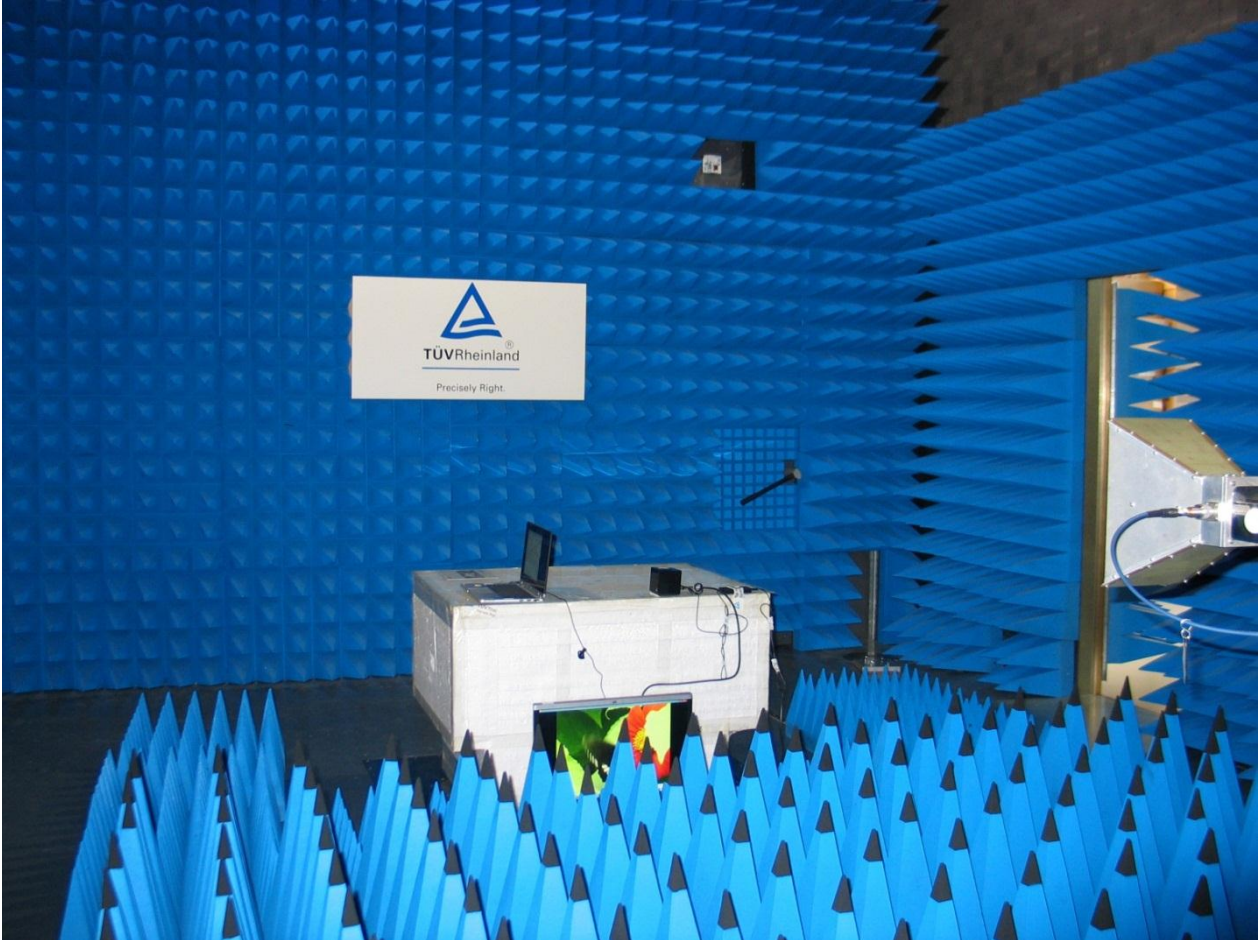
1.3 EUT frontside



1.4 Set-up RF Radiated Emission up to 1 GHz



1.5 Set-up RF Radiated Emission > 1 GHz



1.6 Set-up for Conducted Emission (Laptop Power Supply)

